

CLICdp Vertex and Tracker Working-Group Plans 2019

CLIC week 2019 – CLICdp plenary January 21st, 2019

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on behalf of the CLIC Vertex and Tracking Detector Technology Working Group

Hybrid planar sensor technology



- Planar pixel sensors bump bonded to r/o ASICs
- Considered for vertex detector

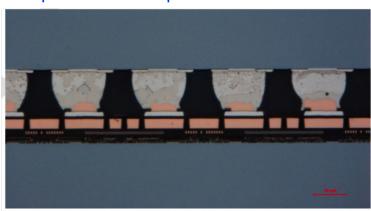
Ongoing work:

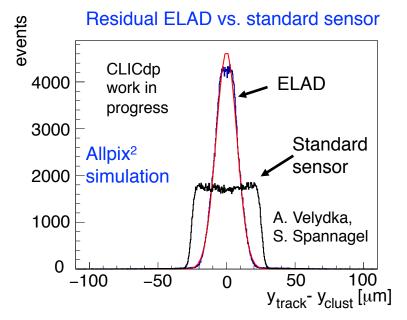
- CLICpix2 planar-sensor assemblies:
 - Bump-bonding process qualification (with IZM)
 - Analysis of SPS test-beam and lab data
- ELAD sensors for enhanced position resolution
 - Sensors designed, simulated (TCAD/Allpix²)
 - Planning for production in progress

Plans for 2019:

- Lab + test-beam measurements for CLICpix2 planar-sensor assemblies
- Bump-bonding of CLICpix2 with from 2nd AIDA-2020 active-edge FBK sensor production (incl. thin sensors ~50 μm)
- First tests of ELAD sensors?

Bump bonded CLICpix2 + Advacam sensor





Capacitively coupled HV-CMOS sensors

- Active HV-CMOS sensors capacitively coupled to r/o ASICs
- Thin glue layer replaces costly small-pitch bump bonds
- Considered for vertex detector

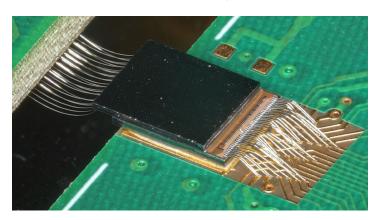
Ongoing work:

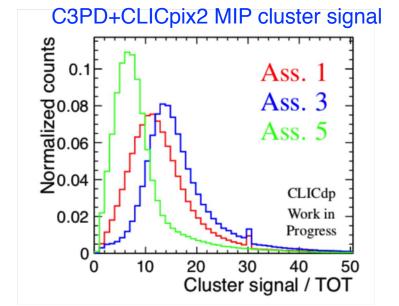
Analysis of C3PD+CLICpix2 SPS TB data for high-resistivity C3PD samples

Plans for 2019:

- Improve calibration procedure (response uniformity); investigate noise behaviour
- Produce and test samples with different resistivities
- Wrap-up the study (PhD thesis Iraklis)

C3PD/CLICpix2 glue assembly





Monolithic HV-CMOS sensors



- High-Voltage-CMOS sensors with integrated readout
- Considered for tracker

Ongoing work:

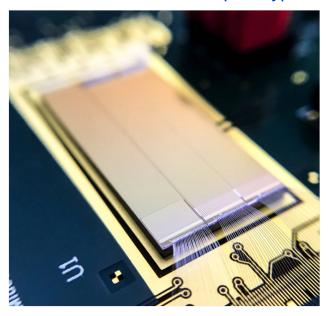
- ATLASPIX prototypes in AMS 180 nm HV-CMOS process:
 40 x 130 μm² pitch, column-drain readout
- Analysis of SPS test-beam data

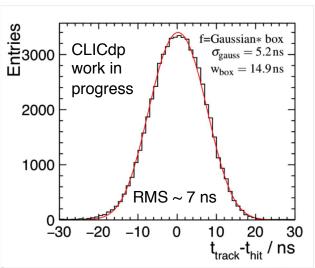
Plans for 2019:

- Sample calibration
- Wrap-up analysis of 2018 test-beam data
- Further beam tests at DESY (rotation scans)
- New submission with adapted geometry, fully targeted to CLIC requirements (smaller width)

Talk by Jens Kröger on Tuesday: Testbeam studies of monolithic HV-CMOS sensors

ATLASPIX HV-CMOS prototype





Integrated HR-CMOS sensors



- CMOS sensors with integrated readout on High-Resistivity (HR) substrate
- Currently considered for tracker

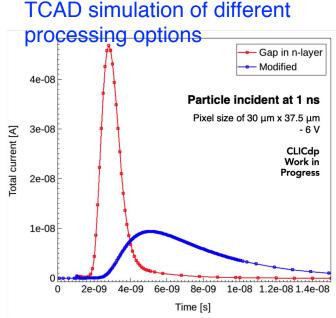
Ongoing works:

- TCAD simulations / optimization of HR-CMOS process (timing, charge-collection efficiency, spatial resolution)
- CLICTD design: technology demonstrator for fully integrated tracker chip in 180 nm TowerJazz process

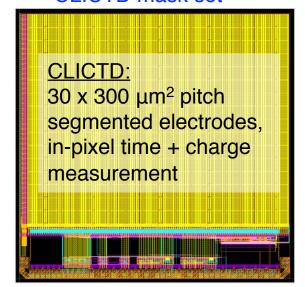
Plans for 2019:

- Submission of CLICTD (target Feb-11)
- CaRIBOu integration of CLICTD
- Lab and test-beam characterization of CLICTD

Talk by Iraklis Kremastiotis on Tuesday: *CLICTD status and plans*



CLICTD mask set



Monolithic SOI sensors



- Sensor and electronics integrated on single wafer with high-resistivity substrate, separated by insulation oxide layer + buried p-wells
- Considered for vertex and tracker

Ongoing work:

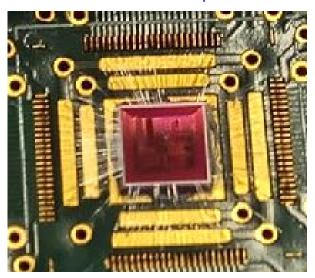
- Analysis of TB data from SOI technology demonstrators
- Production of CLIPS test chip targeted towards CLIC vertex requirements

Plans for 2019:

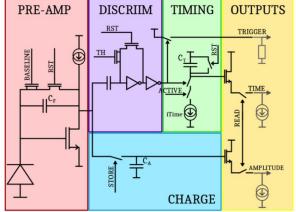
- Wrap-up TB analysis results (PhD thesis Szymon and Roma Bugiel)
- CaRIBOu DAQ for CLIPS: chip board, firmware, software
- First lab and beam tests for CLIPS?

Talk by Roma Bugiel on Tuesday: SOI testbeam analysis Talk by Szymon Bugiel on Tuesday: Status of CLIPS monolithic SOI CMOS chip

Cracow SOI test chip









Device and Monte Carlo simulations



- TCAD device simulations of pixel sensors
- Allpix2 MC simulations: combines Geant4, drift-diffusion model, TCAD fields

Ongoing work:

- 3D TCAD simulation of CMOS sensors
- Allpix² release v.1.3.1
- Modeling of CMOS sensors, validation with TB data

Plans for 2019:

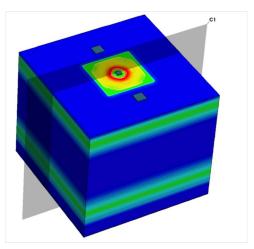
- Allpix² extensions: transient simulations (timing), charge multiplication, life time, multi-threading
- More Allpix² use cases / validation (e.g. ATLASpix)
- 3D TCAD and Allpix² simulations for sensor optimization / comparison with data

3D TCAD electrostatic

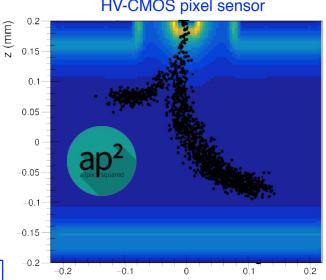
3D TCAD transient:
Precise sensor modeling
--> Timing

Allpix2 Monte Carlo simulation:
Stochastic effects
→ Clustering, efficiency,
spatial resolution

3D TCAD simulation of E-field in HR-CMOS sensor



MIP in under-depleted HV-CMOS pixel sensor



Talk by Magdalena Munker on Tuesday: TCAD simulation of CMOS sensors

DAQ



CaRIBOu: flexible scalable DAQ hardware and software system for pixel-detector R&D

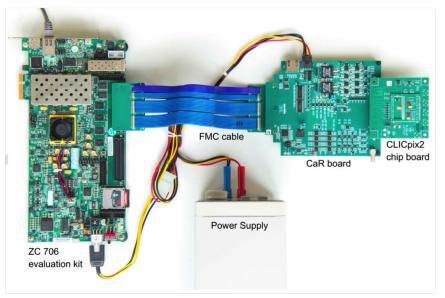
Ongoing work:

- Consolidation of firmware architecture, to improve re-usability of common blocks
- Clean-up of Peary software framework, to improve maintainability

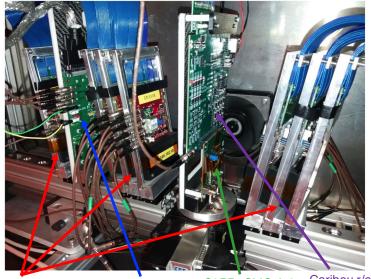
Plans for 2019:

- CaRIBOu integration in DESY test-beam DAQ (EUDAQ2)
- CLICTD, CLIPS integration
- New CaR board hardware release with enhanced features
- User manual

Caribou lab setup



C3PD+CLICpix2 with CaR board in test beam



7 Timepix3 Cracow SOI DUT telescope planes

C3PD+CLICpix2 assembly

Caribou r/o board

2019 beam tests at DESY



- CERN SPS beam-test facility not operational during LHC LS2 (2019/20)
- Beam tests at DESY II (~5.4 GeV electrons), like in 2012/13 during LS1
- Preparations for mechanics and DAQ integration in DESY infrastructure (EUDET telescope / EUDAQ2)
- 5 x 1 week of CLICdp pixel beam time in 2019
- Planned TB programme:
 - EUDAQ2 integration:
 - Timepix3 (SPIDR r/o) timing plane
 - CaRIBOu hardware + software
 - Commissioning and data-taking:
 - ATLASpix (incl. rotation scans)
 - CLICpix2 planar sensor assemblies
 - CLICTD
 - CLIPS?
 - ELAD?



DESY Te

Ralf Diener, Norbert Meyners, Marcel Stanitzki - DESY Test Beam Coorc

	Week		TB21	
				DATURA
7-Jan-19	2			
14-Jan-19	3			
21-Jan-19	4			
28-Jan-19	5		Startup	
4-Feb-19	6		CMS-Pixel-Phase2	Х
11-Feb-19	7		CMS-Pixel-Phase2	Х
18-Feb-19	8		CLIC PIXEL	Х
25-Feb-19	9		ELAD	х
4-Mar-19	10		ATLAS-X0	х
11-Mar-19	11		CMS-Pixel-Phase2	Х
18-Mar-19	12		CMS-Pixel-Phase2	х
25-Mar-19	13		TBMST	Х
1-Apr-19	14		ACDC	
8-Apr-19	15		CMS-Pixel-Phase2	Х
15-Apr-19	16		CMS-Pixel-Phase2	Х
22-Apr-19	17		Setup Time	
29-Apr-19	18		ATLAS-ITk-Strips	Х
6-May-19	19		CMS Outer Tracker	Х
13-May-19	20		CMS Outer Tracker	Х
20-May-19	21		CMS-Pixel-Phase2	Х
27-May-19	22		CMS-Pixel-Phase2	Х
3-Jun-19	23			
10-Jun-19	24		CLIC PIXEL	Х
17-Jun-19	25		TBMST	Х
24-Jun-19	26		CMS-Pixel-Phase2	Х
1-Jul-19	27		CMS-Pixel-Phase2	х
8-Jul-19	28		GammaMeV	Х
15-Jul-19	29		CLIC PIXEL	х
22-Jul-19	30		X-Ray-Crystal-Rad	Х